

FSA201 USB2.0 Full-Speed and Audio Switches with Negative Signal Capability

Features

- 3Ω Typical ON Resistance
- -3db Bandwidth: > 250MHz
- Low Power Consumption
- Packaged in Pb-free 10-Lead MicroPak™ (1.6 x 2.1mm), 10-pin MSOP (Preliminary)
- Power-off Protection on Common D+/R, D-/L Ports
- Automatically Detects V_{bus} for Switch Path Selection

Applications

- Cell Phone, PDA, Digital Camera, and Notebook
- LCD Monitor, TV, and Set-top Box

Description

The FSA201 is a Double-Pole, Double Throw (DPDT) multiplexer that combines a low-distortion audio and a USB2.0 Full-Speed (FS) switch path. This configuration enables audio and USB data to share a common connector port. The architecture is designed to allow audio signals to swing below ground. This means a common USB and headphone jack can be used for personal media players and similar portable peripheral devices.

Since USB2.0 is an industry standard for shared data-path in portable devices, the FSA201 also incorporates a V_{bus} detection capability. The FSA201 includes a power-off feature to minimize current consumption when V_{bus} is not present. This power-off circuitry is available for the common D+/R, D-/L ports only. Typical applications involve switching in portables and consumer applications, such as cell phones, digital cameras, and notebooks with hubs or controllers.

Ordering Information

Part Number	Package Number	Pb-Free	Packing Description
FSA201L10X	MAC010A	Yes	10-Lead MicroPak, 1.6 mm X 2.1mm
FSA201MUX (Preliminary)	MUA10A	Yes	10-Lead MSOP JEDEC MO-187, 3.0 mm Wide

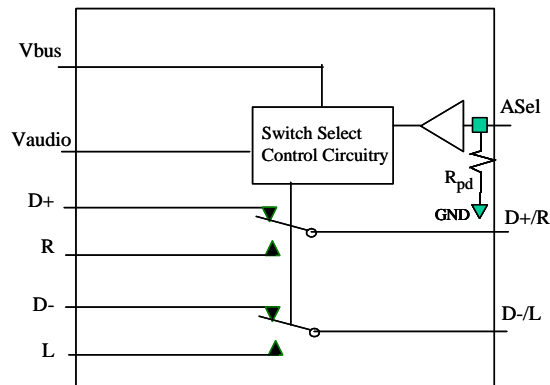


Figure 1. FSA201 Analog Symbol

Pin Assignments

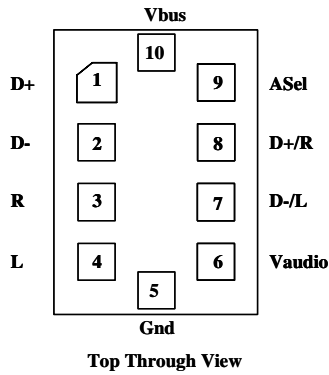


Figure 2. MicroPak 10-Pin Assignment

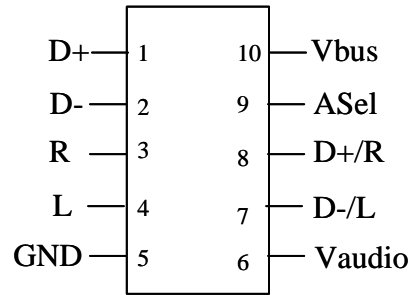


Figure 3. MSOP 10-Pin Assignment

Pin Descriptions

Pin #	Name	Description
1, 2	D+, D-	USB data bus input sources
6	V _{audio}	Power supply (audio)
3, 4	R, L	Audio right and left input sources
9	A _{Sel}	Audio select to override auto USB detect when V _{AUDIO} supply is present
10	V _{bus}	Power supply (USB) and auto USB switch-path select
8, 7	D+/R, D-/L	USB and audio common connector ports

Truth Table

A _{Sel} ⁽¹⁾	V _{audio}	V _{bus}	L, R	D+, D-
L	L	L	OFF	OFF
L	L	H ⁽²⁾	OFF	ON
L	H ⁽²⁾	L	ON	OFF
L	H ⁽²⁾	H ⁽²⁾	OFF	ON
H	L	L	OFF	OFF
H	L	H ⁽²⁾	OFF	ON
H	H ⁽²⁾	L	ON	OFF
H	H ⁽²⁾	H ⁽²⁾	ON	OFF

Notes:

1. A_{Sel} - Internal resistor to GND provides auto-V_{bus} detect if there is no external connection. Forcing A_{Sel} HIGH when V_{AUDIO} is present overrides the USB path even if V_{bus} is present.
2. H - Value is the threshold as defined to meet USB2.0 V_{bus} requirements and audio supply threshold in a system (see DC Tables).

Functional Description

The FSA201 is a combined USB and audio switch that enables sharing the D+/D- lines of a USB connector with stereo audio CODEC outputs. The switch is optimized for full-speed USB signals and includes an automatic V_{bus} -detection circuit. When a USB connector, rather than a headphone, is connected to the ultra-portable device the switch is automatically configured for full-speed USB data transfer. If no V_{bus} is detected, and yet V_{AUDIO} is present, the switch is configured for the low-distortion audio switch path. The audio switch path also handles negative signals (down to -2V), which eliminates the need for large coupling capacitors.

For those applications where the V_{bus} is generated as a self-powered device or where V_{bus} is not removed, the A_{Sel} pin provides the ability to switch, under software control, to the audio path. The A_{Sel} pin is internally

terminated by a resistor to GND (typical value $3M\Omega$) and requires no connection for the standard ultra-portable (cell-phone, MP3, or Portable Media Player). In an application where the supply to the FSA201 V_{bus} pin is not guaranteed to be removed, a GPIO pin can be used to switch out of full-speed USB mode into audio mode, using the A_{Sel} pin.

The FSA201 V_{bus} pin must be connected directly to V_{bus} or a supply $> 3.8V$, not an LDO regulated down to 3.6V or a V_{bat} -generated supply that may fall below 3.8V in normal operation (see the Application Diagram).

Application Diagram

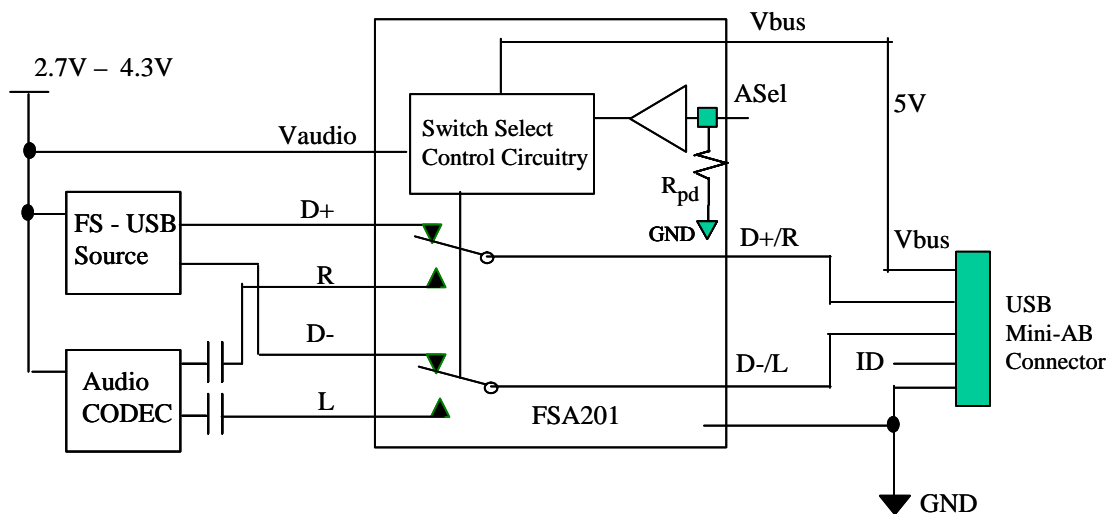


Figure 4. Application Diagram

Absolute Maximum Ratings

The “Absolute Maximum Ratings” are those values beyond which the safety of the device cannot be guaranteed. The device should not be operated at these limits. The parametric values defined in the Electrical Characteristics tables are not guaranteed at the absolute maximum ratings. The “Recommended Operating Conditions” table defines the conditions for actual device operation.

Symbol	Parameter	Conditions
V_{Audio}	Supply Voltage	-0.5V to 6.0V
V_{bus}	Supply Voltage	-0.5V to 6.0V
V_{SW}	Switch I/O Voltage ⁽³⁾	R, L Pins ($V_{audio} - 5.5V$) to ($V_{audio} + 0.3V$)
		D+, D-, D+/R, D-/L Pins ($V_{bus} - 5.5V$) to ($V_{bus} + 0.3V$)
A_{Sel}	Control Input Voltage ⁽³⁾	-0.5V to + 6.0V
	Input Clamp Diode Current	- 50mA
	Switch I/O Current (Continuous)	USB
		Audio
	Peak Switch Current (Pulsed at 1mS Duration, <10% Duty Cycle)	USB
		Audio
T_{STG}	Storage Temperature Range	-65°C to +150°C
T_J	Maximum Junction Temperature	+150°C
T_L	Lead Temperature (Soldering, 10 seconds)	+260°C
ESD	Human Body Model (JEDEC: JESD22-A114)	I/O to GND
		All Other Pins
	Charge Discharge Model (JEDEC-JESD-C101)	2kV

Notes:

- The input and output negative ratings may be exceeded if the input and output diode current ratings are observed.

Recommended Operating Conditions⁽⁴⁾

Symbol	Parameter	Conditions
V_{Audio}	Supply Voltage	2.7V to 4.3V
V_{bus}	Supply Voltage	4.25V to 5.5V
A_{Sel}	Control Input Voltage	0V to V_{Audio}
V_{SW}	Switch I/O Voltage	($V_{Audio} - 5.5$) to V_{Audio}
T_A	Operating Temperature	-40°C to 85°C
θ_{JA}	Thermal Resistance (free air)	MicroPak 10L package 330°C / W (estimated)

Notes:

- Recommended operating conditions are specified to ensure optimal performance to the datasheet specifications. Fairchild does not recommend exceeding or designing to Absolute Max Ratings.

PRELIMINARY

DC Electrical Characteristics

All typical values are @ 25°C unless otherwise specified.

Symbol	Parameter	V _{Audio} (V)	Conditions	T _A = - 40°C to +85°C			Unit
				Min.	Typ.	Max.	
Common Pins							
V _{IK}	Clamp Diode Voltage	2.7	I _{IK} = -18mA			-1.2	V
V _{IH}	Control Input Voltage HIGH	2.7 to 3.6		1.3			
		3.6 to 4.3		1.5			
V _{IL}	Control Input Voltage LOW	2.7 to 4.3				0.5	
I _{IN}	A _{Sel} Input HIGH Current	4.3	V _{CNTRL} = 0V to 4.3V	-3		3	μA
I _{OFF}	Power Off Leakage Current (Common Port Only D+/R, D-/L)	V _{audio} = V _{bus} = 0V	Common Port (D+/R, D-/L) V _{SW} = 0V to 5.5V			1	μA
I _{NO(OFF)}	OFF-Leakage Current of Port D+, D-, R, L	4.3	V _{bus} = 0V, 5.5V D+/R, D-/L = 0.3V, V _{AUDIO} - 0.3V D+, D-, R, L = 0.3V, V _{AUDIO} - 0.3V or Floating See Figure 14	-50	10	50	nA
I _{NC(ON)}	ON-Leakage Current of Port D+/R or D-/L	4.3	V _{bus} = 0V, 5.5V D+/R, D-/L = 0.3V, V _{AUDIO} - 0.3V D+, D-, R, L = Floating See Figure 15	-100	50	100	nA
USB Switch Path							
	USB Analog Signal Range			0		3.6	V
R _{ONUSB}	FS Switch ON Resistance ⁽⁵⁾	4.25	V _{D+/D-} = 0V, 3.0V, I _{ON} = -8mA See Figures 5, 6, 13		3	6	Ω
Δ R _{ONUSB}	FS Delta R _{ON} ^(5,7)	4.25	V _{D+/D-} = 3V, I _{ON} = -8mA		0.35		Ω
Audio Switch Path							
	Audio Analog Signal Range			V _{audio} - 5.5		V _{audio}	
R _{ONAudio}	Audio Switch ON Resistance ⁽⁸⁾	2.7	V _{L/R} = -2V, 0V, 0.7V, V _{AUDIO} -0.7V, V _{AUDIO} I _{ON} = -100mA V _{bus} = 0V See Figures 5, 6, 13			1.0	Ω
Δ R _{ONAudio}	Audio Delta R _{ON} ⁽⁵⁾	2.7	V _{L/R} = 0.7V I _{ON} = -100mA		0.01	0.1	Ω
R _{FLAT(Audio)}	Audio R _{ON} Flatness ⁽⁶⁾	2.7	V _{L/R} = -2V, 0V, 0.7V, 2V, 2.7V I _{ON} = -100mA			0.35	Ω

Notes:

5. Δ R_{ON} = R_{ON max} - R_{ON min} measured at identical V_{CC}, temperature, and voltage. Worst-case signal path, audio or USB channel, is characterized.
6. Flatness is defined as the difference between the maximum and minimum values of on resistance over the specified range of conditions.
7. Guaranteed by characterization, not production tested.
8. On resistance is determined by the voltage drop between the A and B pins at the indicated current through the switch.

PRELIMINARY

DC Electrical Characteristics (Continued)

All typical values are @25°C unless otherwise specified.

Symbol	Parameter	V _{Audio} (V)	Conditions	T _A = - 40°C to +85°C			Unit
				Min.	Typ.	Max.	
Power Supply							
V _{busth}	V _{bus} Threshold Voltage			3.2		3.8	V
V _{audioth}	V _{audio} Threshold			0.5		1.5	V
I _{CC(Audio)}	Quiescent Supply Current (Audio)	4.3	V _{ASel} = 0 to V _{audio} , I _{OUT} =0			10	μA
I _{CC(Vbus)}	Quiescent Supply Current (V _{bus})		V _{ASel} = 0 to V _{audio} , I _{OUT} =0 V _{bus} = 5.5V			20	μA
I _{CCT}	Increase in I _{CC} current per control voltage and V _{CC}	4.3	V _{ASel} = 2.6V, V _{bus} = floating			15	μA
			V _{ASel} = 1.8V, V _{bus} = floating			18	

PRELIMINARY

AC Electrical Characteristics

All typical value are for $V_{\text{AUDIO}} = 3.3\text{V}$, $V_{\text{bus}} = 5.0$ @25°C unless otherwise specified.

Symbol	Parameter	$V_{\text{audio}}/V_{\text{bus}}$ (V)	Conditions	$T_A = -40^\circ\text{C to } +85^\circ\text{C}$			Unit
				Min.	Typ.	Max.	
T_{ONAUDIO1}	Turn-ON Time $V_{\text{AUDIO}} \uparrow$ to Output	$V_{\text{bus}} = 0\text{V}$	$V_{\text{D+}/\text{R}, \text{D-}/\text{L}} = 1.0\text{V}$ $R_L = 50\Omega$, $C_L = 50\text{pF}$ See Figures 16, 18			10	μs
$T_{\text{OFFAUDIO1}}$	Turn-OFF Time $V_{\text{Bus}} \uparrow$ to Output	$V_{\text{AUDIO}} = 2.7$ for $V_{\text{bus}} \uparrow$	$V_{\text{D+}/\text{R}, \text{D-}/\text{L}} = 1.0\text{V}$ $R_L = 50\Omega$, $C_L = 50\text{pF}$ See Figures 16, 18			10	μs
T_{ONAUDIO2}	Turn-ON Time A_{Sel} to Output	$V_{\text{bus}} = 4.25\text{V}$ $V_{\text{AUDIO}} = 2.7$	$V_{\text{D+}/\text{R}, \text{D-}/\text{L}} = 1.0\text{V}$ $R_L = 50\Omega$, $C_L = 50\text{pF}$ See Figures 16, 17			1	μs
$T_{\text{OFFAUDIO2}}$	Turn-OFF Time A_{Sel} to Output	$V_{\text{bus}} = 4.25\text{V}$ $V_{\text{AUDIO}} = 2.7$	$V_{\text{D+}/\text{R}, \text{D-}/\text{L}} = 1.0\text{V}$ See Figures 16, 18			1	μs
T_{ONAUDIO3}	Turn-ON Time $V_{\text{Bus}} \downarrow$ to Output	$V_{\text{AUDIO}} = 2.7$	$V_{\text{D+}/\text{R}, \text{D-}/\text{L}} = 1.0\text{V}$ $R_L = 50\Omega$, $C_L = 50\text{pF}$ See Figures 16, 17			10	μs
T_{ONUSB}	Turn-ON Time $V_{\text{USB}} \uparrow$ to Output	$V_{\text{AUDIO}} = 2.7$	$V_{\text{D+}/\text{R}, \text{D-}/\text{L}} = 1.0\text{V}$ $R_L = 50\Omega$, $C_L = 50\text{pF}$ See Figures 16, 18			10	Ms
T_{OFFUSB}	Turn-OFF Time $V_{\text{USB}} \downarrow$ to Output	$V_{\text{AUDIO}} = 2.7$	$V_{\text{D+}/\text{R}, \text{D-}/\text{L}} = 1.0\text{V}$ $R_L = 50\Omega$, $C_L = 50\text{pF}$ See Figures 16, 18			10	μs
T_{PDUSB}	USB Switch Propagation Delay ⁽⁸⁾	$V_{\text{AUDIO}} = 2.7$ $V_{\text{bus}} = 4.25\text{V}$	$R_L = 50\Omega$, $C_L = 50\text{pF}$ See Figure 19		0.25		ns
O_{IRRUSB}	OFF-Isolation USB	$V_{\text{AUDIO}} = 2.7$ $V_{\text{bus}} = 4.25\text{V}$	$F = 6\text{MHz}$, $R_T = 50\Omega$, $C_L = 5\text{pF}$ See Figures 7, 8, 23		-60		dB
O_{IRRA}	OFF-Isolation Audio	$V_{\text{AUDIO}} = 2.7$ $V_{\text{bus}} = 4.25\text{V}$	$F = 6\text{MHz}$, $R_T = 50\Omega$, $C_L = 5\text{pF}$ See Figures 7, 8, 23		-37		dB
X_{talkUSB}	Non-Adjacent Channel Crosstalk - USB	$V_{\text{AUDIO}} = 2.7$ $V_{\text{bus}} = 4.25\text{V}$	$R_T = 50\Omega$, $C_L = 5\text{pF}$, $f = 6\text{MHz}$ See Figures 9, 10, 24		-49		dB
X_{talkA}	Non-Adjacent Channel Crosstalk - Audio	$V_{\text{AUDIO}} = 2.7$ $V_{\text{bus}} = 4.25\text{V}$	$R_T = 50\Omega$, $C_L = 5\text{pF}$ $f = 6\text{MHz}$ See Figures 9, 10, 24		-39		dB
BW	-3db Bandwidth	$V_{\text{AUDIO}} = 2.7$ $V_{\text{bus}} = 4.25\text{V}$	$R_T = 50\Omega$, $C_L = 5\text{pF}$, signal 0dBm See Figures 11, 12, 22		250		MHz
THD	Total Harmonic Distortion	$V_{\text{AUDIO}} = 2.7$ $V_{\text{bus}} = 0\text{V}$	$R_L = 32\Omega$, $f = 20\text{Hz to } 20\text{kHz}$ $V_{\text{R,L}} = 2.0\text{Vpk-pk}$ See Figure 27		0.05		%
PSRR	Power Supply Rejection Ratio	$V_{\text{AUDIO}} = 4.0$ $V_{\text{bus}} = 0\text{V}$	$V_{\text{R,L}} = 1.0\text{V}$, $R_T = 32\Omega$, $V_{\text{Ripple}} = 600\text{mVpk-pk}$ $f = 217\text{Hz on } V_{\text{AUDIO}}$		-60		dB

USB Full-Speed Related AC Electrical Characteristics

Symbol	Parameter	V _{audio} / V _{bus} (V)	Conditions	T _A =- 40°C to +85°C			Unit
				Min.	Typ.	Max.	
t _{SK(O)}	Channel-to-Channel Skew ⁽⁹⁾	V _{audio} = 2.7V V _{bus} = 4.25V	t _R = t _F = 12ns (10-90%) at 6MHz C _L = 50pF, R _L = 50Ω See Figures 20, 21		150		ps
t _{SK(P)}	Skew of Opposite Transitions of the Same Output ⁽⁹⁾	V _{audio} = 2.7V V _{bus} = 4.25V			150		
t _J	Total Jitter ⁽⁹⁾	V _{audio} = 2.7V V _{bus} = 4.25V	R _L = 50Ω, C _L = 50pF, t _R = t _F = 12ns (10-90%) at 12Mbps (PRBS = 2 ¹⁵ - 1)		1.6		ns

Notes:

9. Guaranteed by characterization, not production tested

Capacitance

Symbol	Parameter	V _{audio} / V _{bus} (V)	Conditions	T _A =- 40°C to +85°C			Unit
				Min.	Typ.	Max.	
C _{iN (ASel)}	Control Pin Input Capacitance (A _{Sel})	V _{audio} = 2.7V V _{bus} = 4.25V	V _{Bias} = 0.2V		2.5		pF
C _{ON(D+/R, D-/L)}	CD+/R, D-/L (Common Port) ON Capacitance	V _{audio} = 2.7V V _{bus} = 4.25V A _{Sel} = 0V (C _{ONUSB})	V _{Bias} = 0.2V f = 6MHz See Figure 26		25		
		V _{audio} = 2.7V V _{bus} = 4.25V A _{Sel} = 2.7V (C _{ONAudio})	V _{Bias} = 0.2V f = 6MHz See Figure 26		32		
C _{OFF(D+, D-)}	USB Input Source OFF Capacitance	V _{audio} = 2.7V V _{bus} = 4.25V A _{Sel} = 2.7V	f = 6MHz See Figure 25		5		
C _{OFF(RL)}	Audio Input Source OFF Capacitance	V _{audio} = 2.7V V _{bus} = 4.25V A _{Sel} = 0V	f = 6MHz See Figure 25		15		

Typical Characteristics

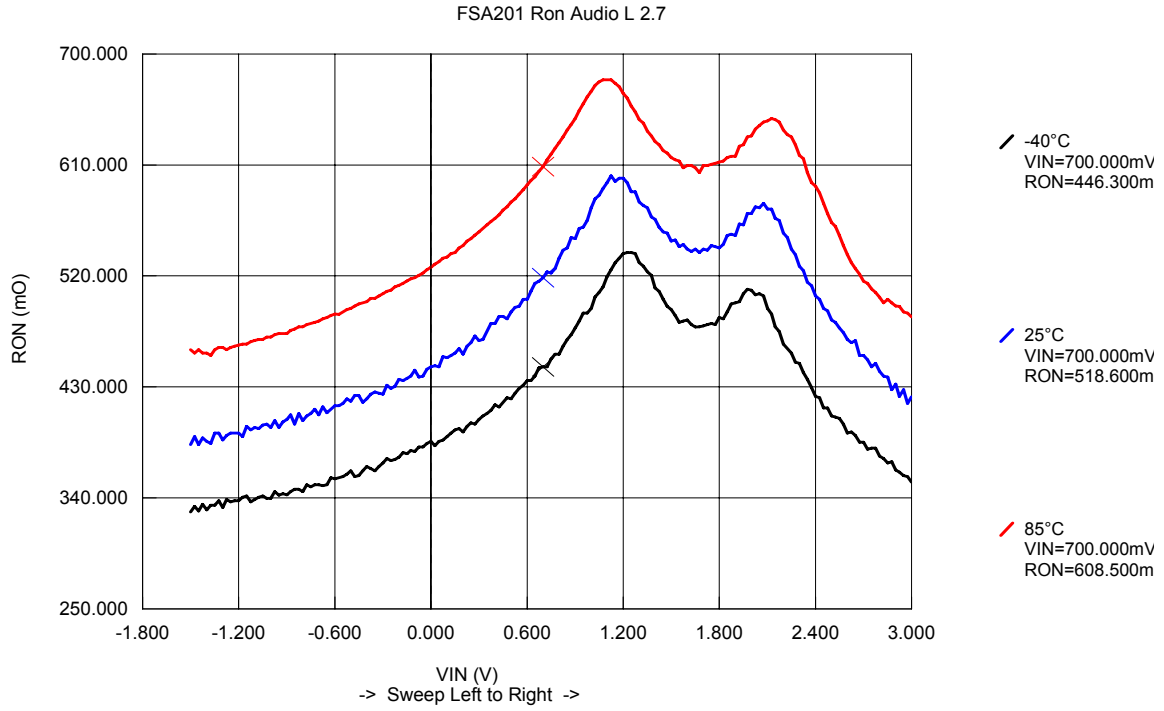


Figure 5. R_{ON} Audio Characterization

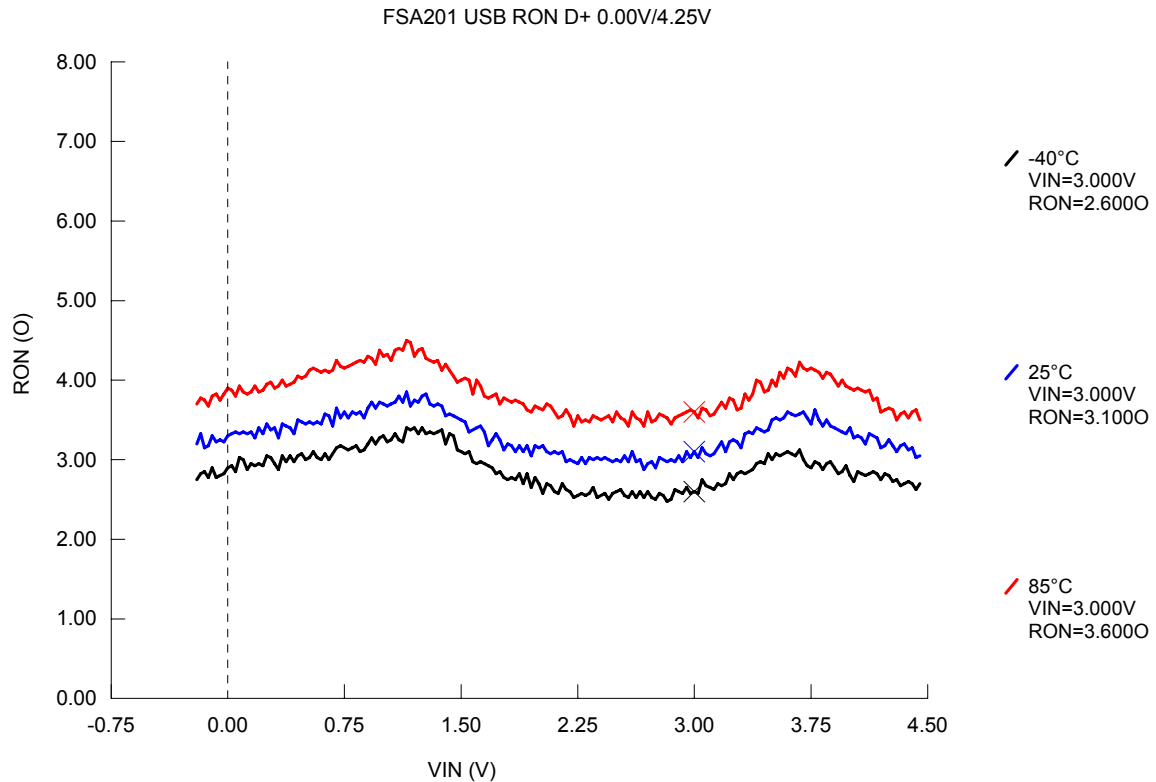


Figure 6. R_{ON} USB Characterization

Typical Characteristics (Continued)

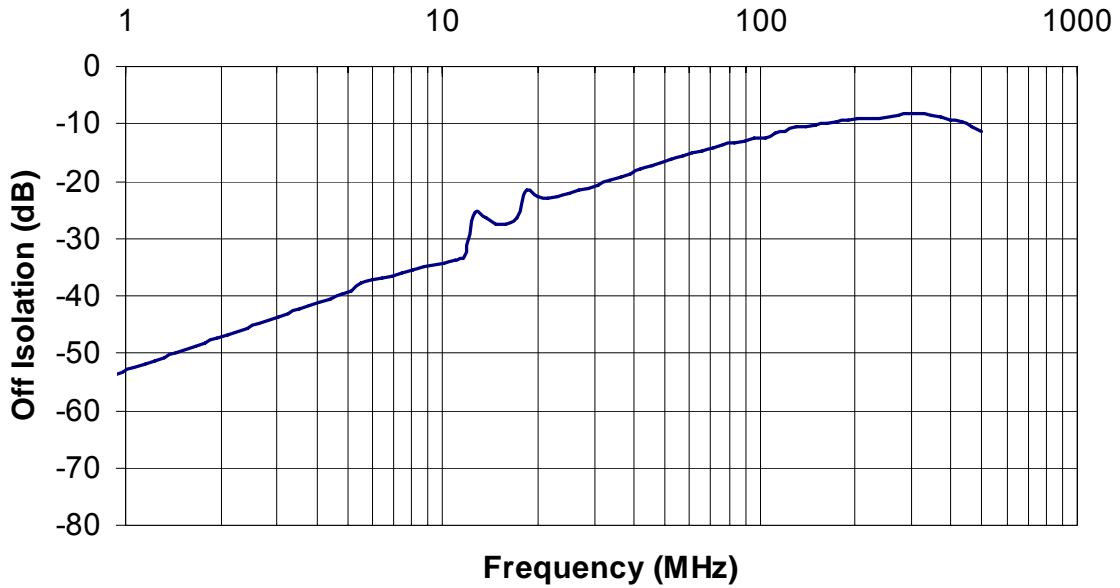


Figure 7. Off-Isolation Characterization Frequency Response at $V_{CC} (V_{AUDIO}) = 2.7V$

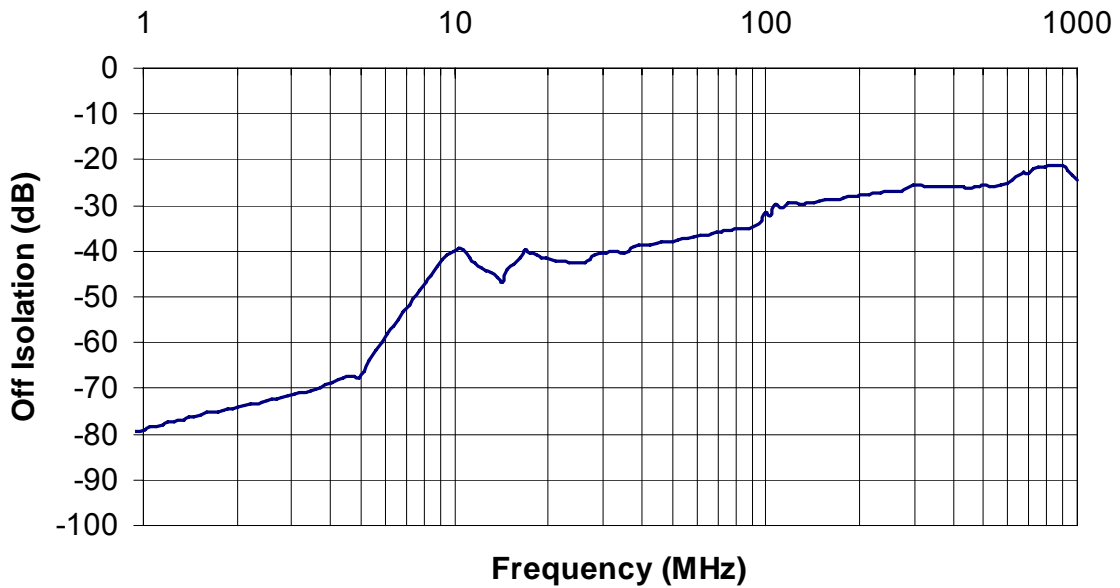


Figure 8. Off-Isolation Characterization Frequency Response at $V_{CC} (V_{BUS}) = 4.3V$

Typical Characteristics (Continued)

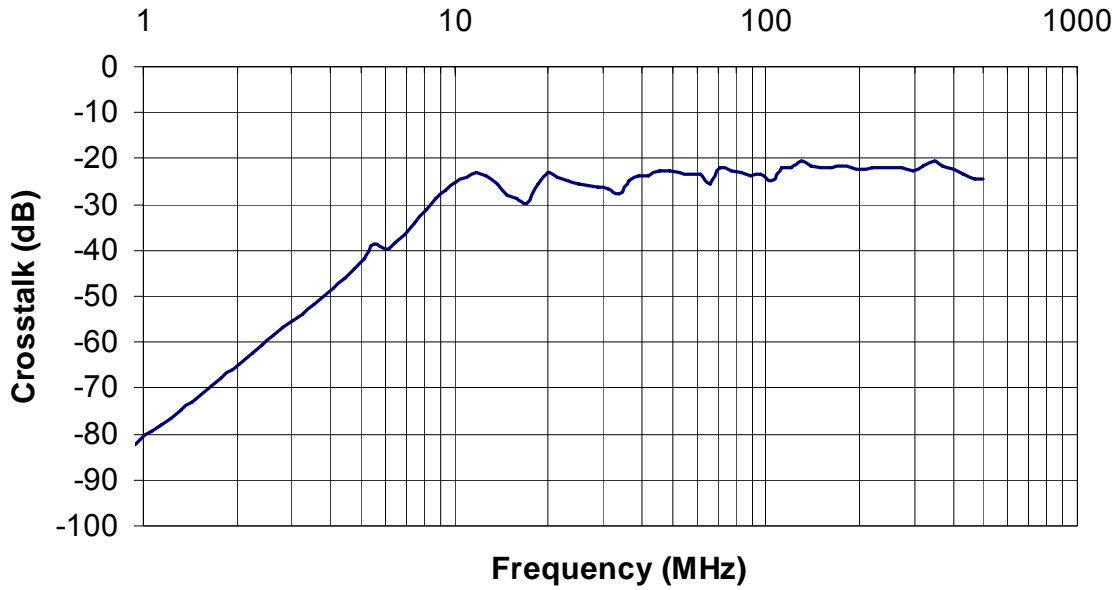


Figure 9. Non-Adjacent Channel Crosstalk Characterization at $V_{CC(VAUDIO)} = 2.7V$

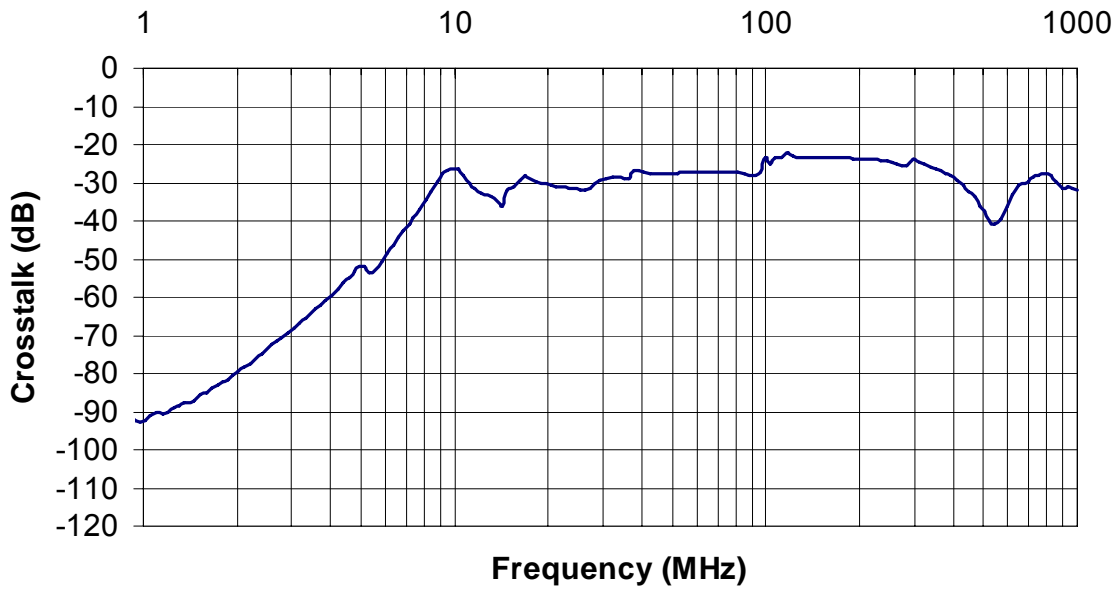


Figure 10. Non-Adjacent Channel Crosstalk Characterization at $V_{CC(Vbus)} = 4.3V$

Typical Characteristics (Continued)

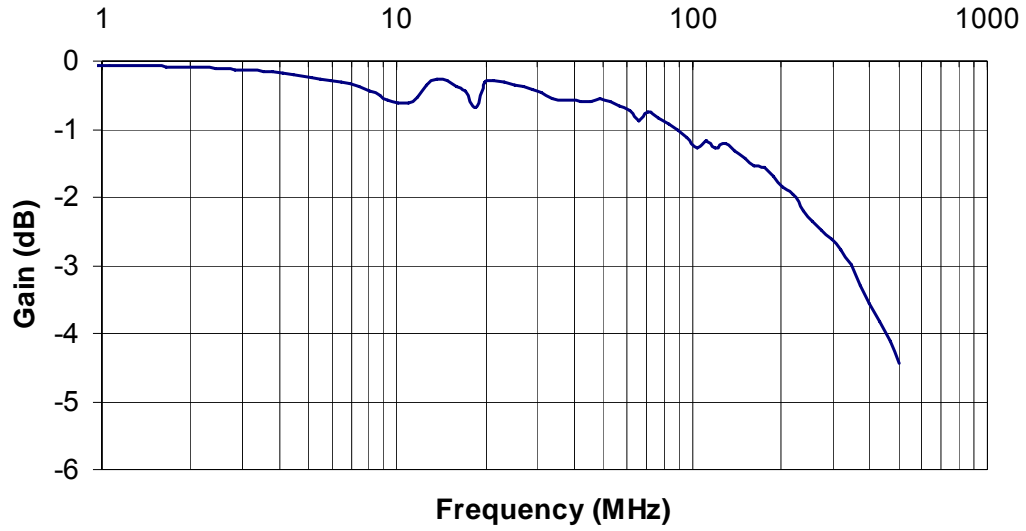


Figure 11. Bandwidth Characterization, Frequency Response at $C_L = 5\text{pF}$, $V_{CC(\text{AUDIO})} = 2.7\text{V}$

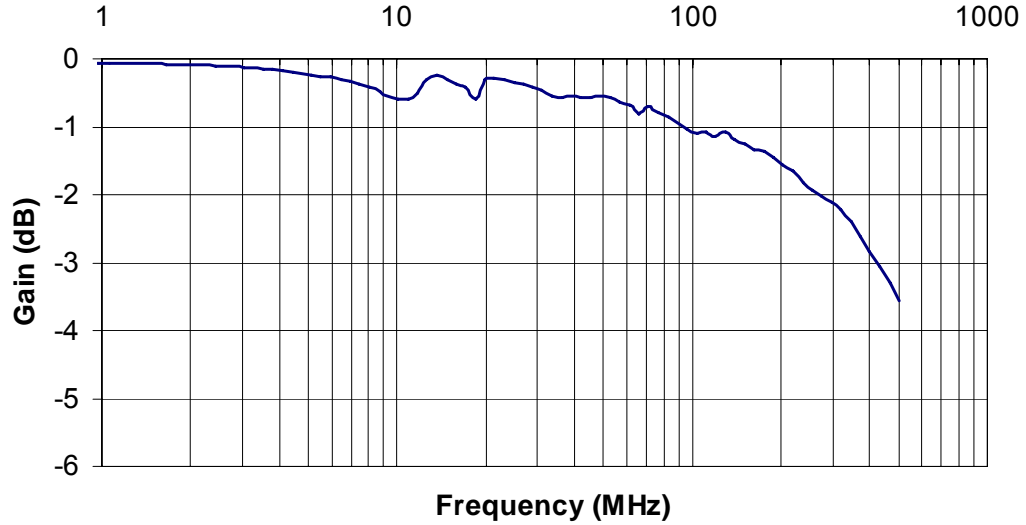


Figure 12. Bandwidth Characterization, Frequency Response at $C_L = 0\text{pF}$, $V_{CC(\text{AUDIO})} = 2.7\text{V}$

Test Diagrams

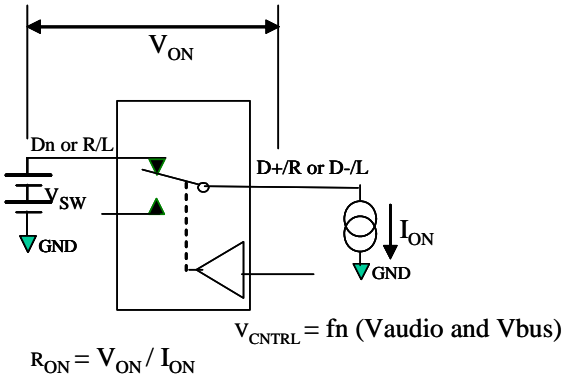


Figure 13. On Resistance

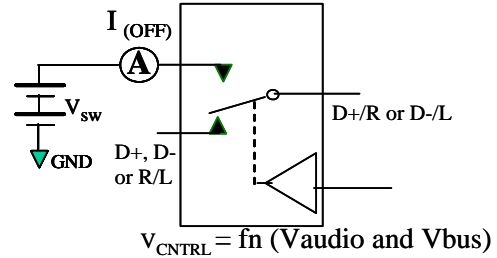


Figure 14. Off Leakage

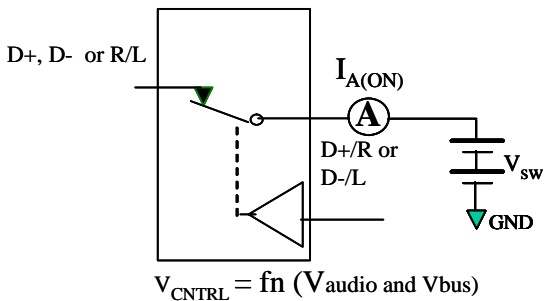
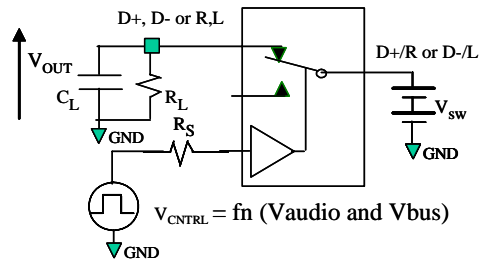


Figure 15. On Leakage



R_L , R_S and C_L are function of application environment (see AC Tables for specific values)
 C_L includes test fixture and stray capacitance

Figure 16. AC Test Circuit Load

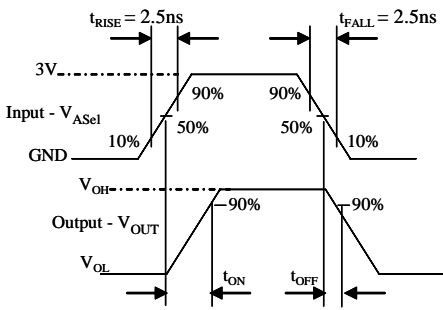


Figure 17. Turn-On / Turn-Off Waveforms (A_{Sel})

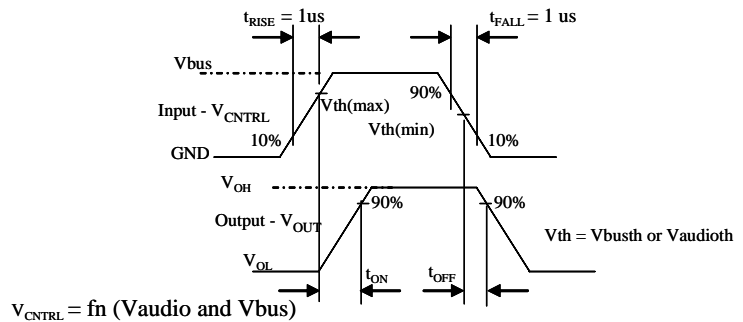


Figure 18. Turn-On / Turn-Off Waveforms (USB/Audio)

Test Diagrams (Continued)

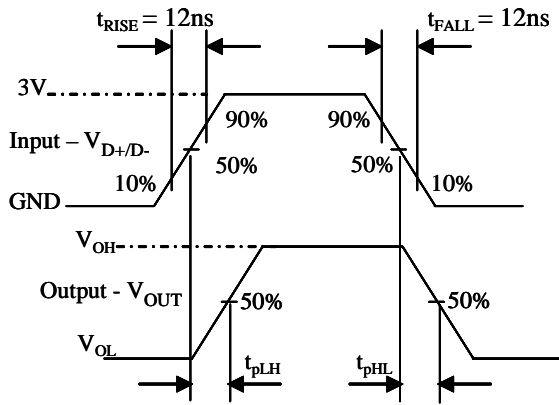


Figure 19. USB Switch Propagation Delay Waveforms

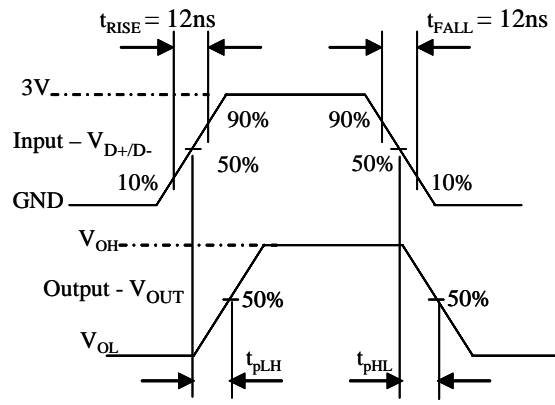


Figure 20. Pulse Skew: $t_{SK(P)} = |t_{pHL} - t_{pLH}|$

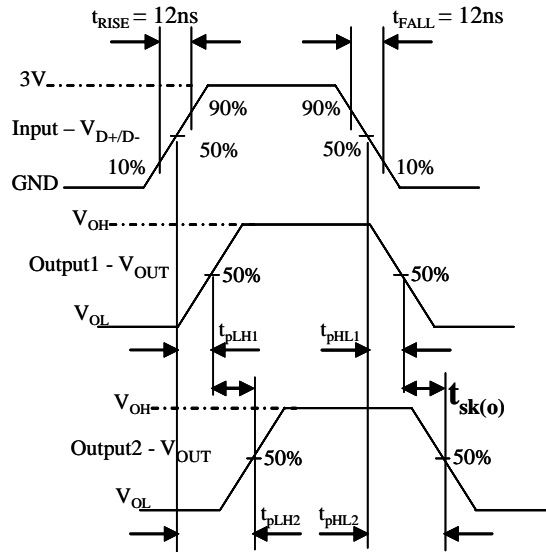


Figure 21. Output Skew: $t_{SK(O)} = |t_{pLH1} - t_{pLH2}|$ or $|t_{pHL1} - t_{pHL2}|$

Test Diagrams (Continued)

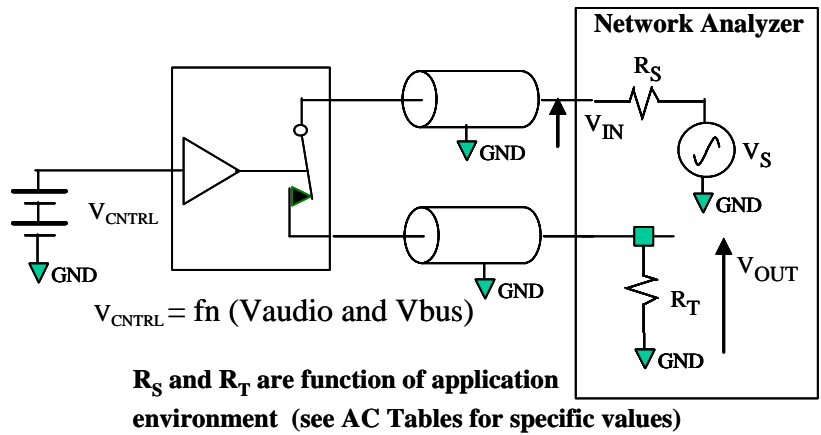
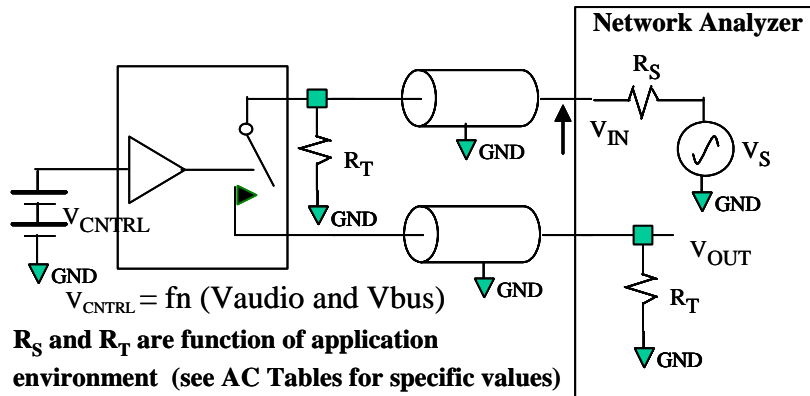
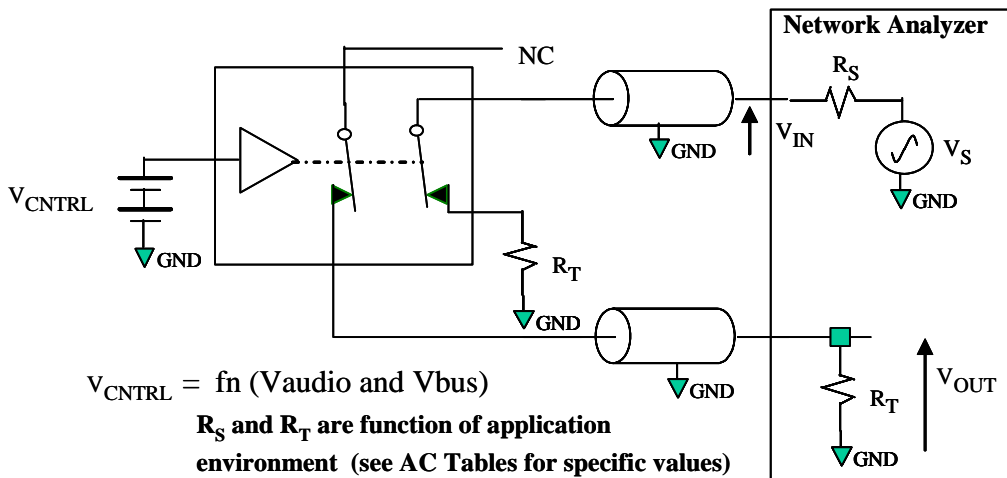


Figure 22. USB Bandwidth



$\text{OFF-Isolation} = 20 \text{ Log}(V_{\text{OUT}} / V_{\text{IN}})$

Figure 23. Channel OFF Isolation



$\text{CROSSTALK} = 20 \text{ Log}(V_{\text{OUT}} / V_{\text{IN}})$

Figure 24. Non-Adjacent Channel-to-Channel Crosstalk

Test Diagrams (Continued)

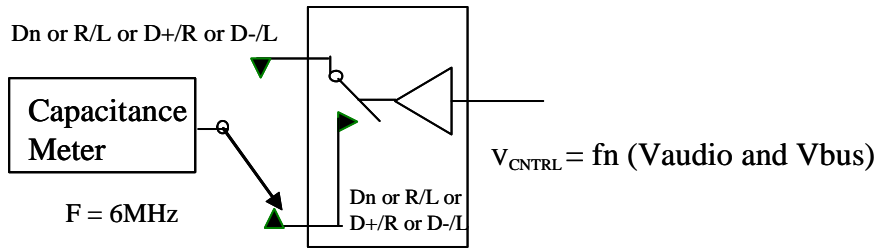


Figure 25. Channel OFF Capacitance

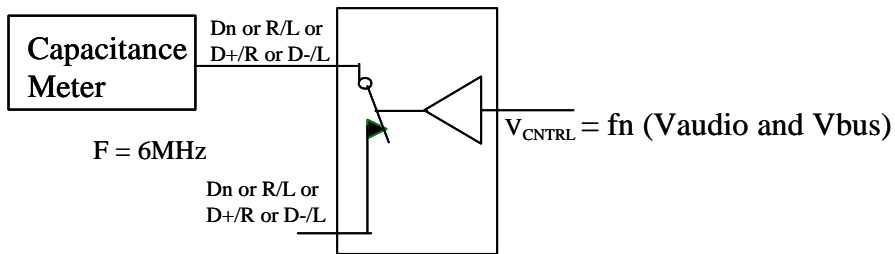


Figure 26. Channel ON Capacitance

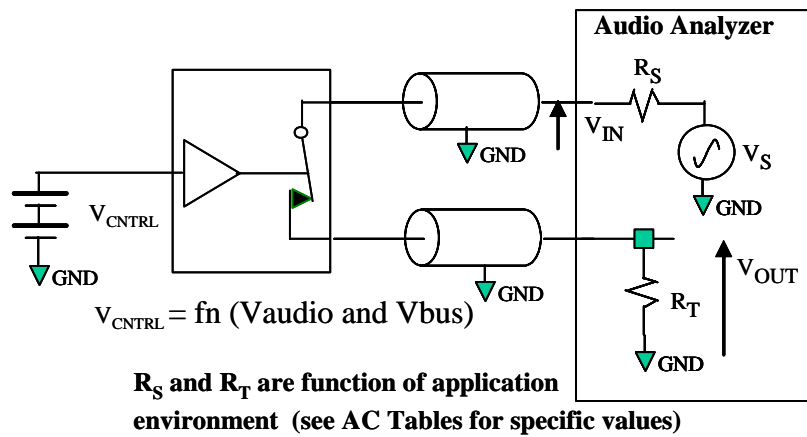
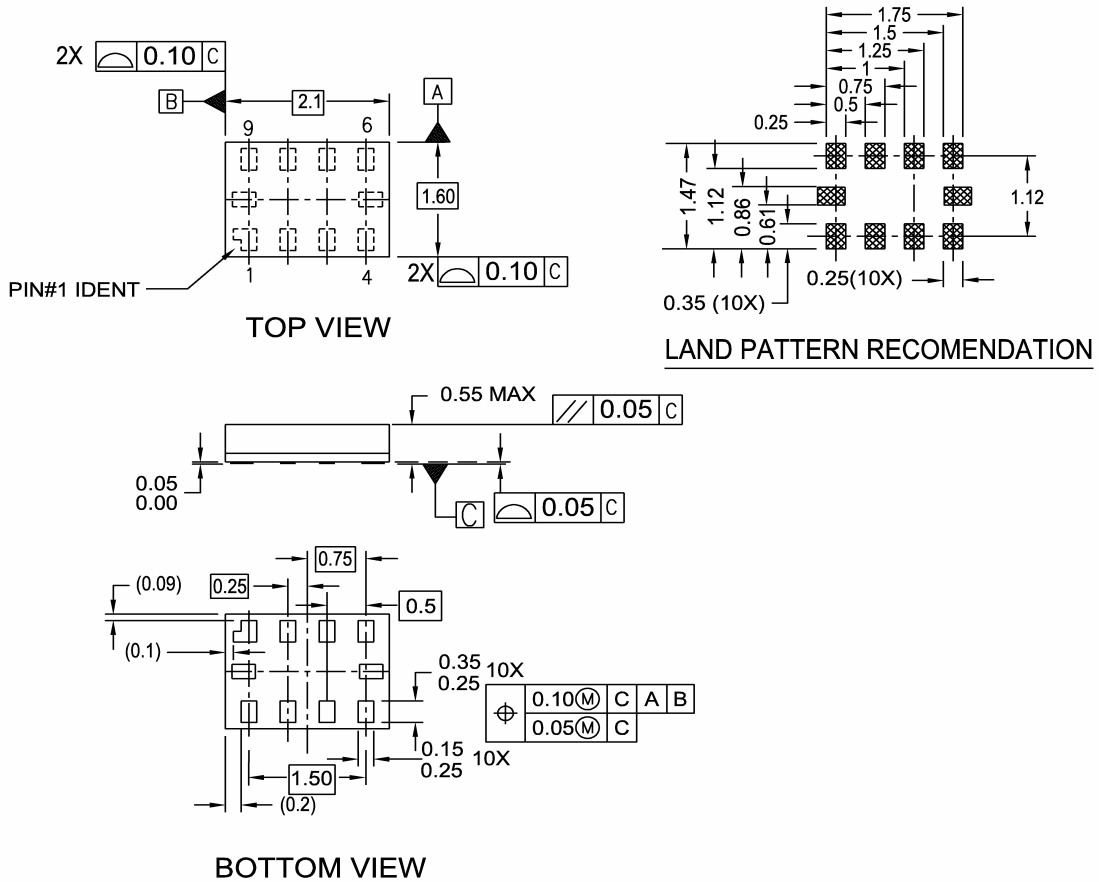


Figure 27. Total Harmonic Distortion

Physical Dimensions

Dimensions are in millimeters unless otherwise noted.



NOTES:

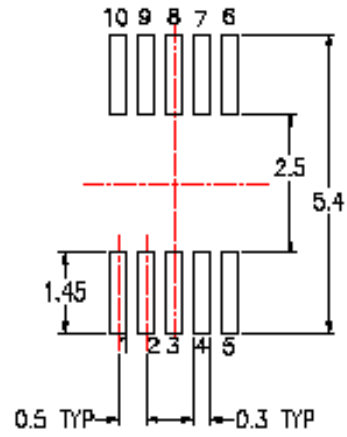
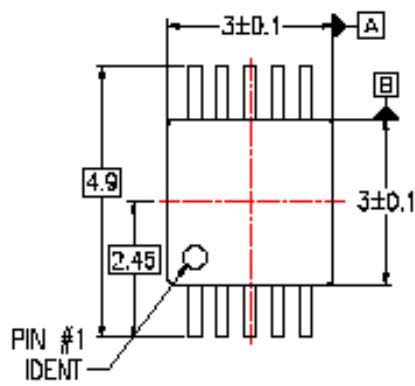
- A. PACKAGE CONFORMS TO JEDEC MO255, VARIATION UABD
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS AND TOLERANCES CONFORMS TO ASME Y14.5M, 1994.

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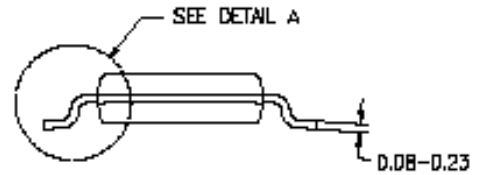
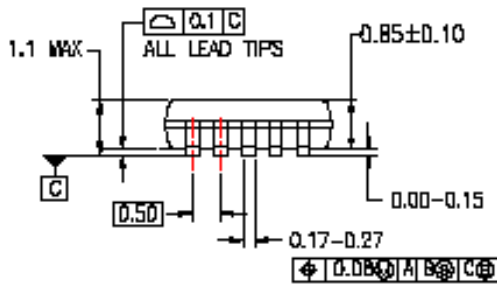
Figure 28. 10-Lead MicroPak FSA201

Physical Dimensions

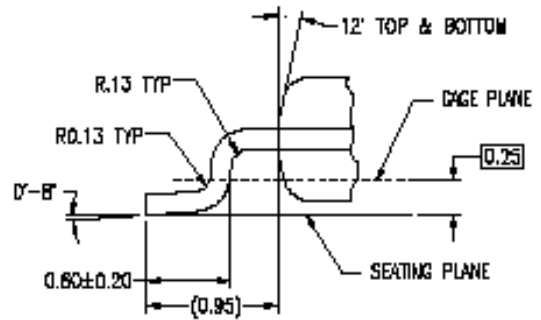
Dimensions are in millimeters unless otherwise noted.



LAND PATTERN RECOMMENDATION



DIMENSIONS ARE IN MILLIMETERS



DETAIL A

NOTES:

- A. CONFORMS TO JEDEC REGISTRATION MO-187, VARIATION BA, REF NOTE 6, DATE 11/00.
- B. DIMENSIONS ARE IN MILLIMETERS.
- C. DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.
- D. DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.

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Figure 29. 10-Lead MSOP FSA201 (Preliminary)

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E ² CMOS™	LittleFET™	PowerTrench®	SuperSOT™-8	UniFET™
EnSigna™	MICROCOUPLER™	QFET®	SyncFET™	VCX™
FACT™	MicroFET™	QS™	TCM™	Wire™
FACT Quiet Series™	MicroPak™	QT Optoelectronics™	TinyBoost™	
FAST®	MICROWIRE™	Quiet Series™		
FASTr™	MSX™	RapidConfigure™	Across the board. Around the world.™	
FPS™	MSXPro™	RapidConnect™	Programmable Active Droop™	
FRFET™	OCX™	ScalarPump™	The Power Franchise®	

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Rev. I20